

## **PRODUCT**

**SOLUTION GUIDE** 

2024

INDUSTRIAL COMPUTING SOLUTIONS FROM THE EDGE TO THE CLOUD

**BEYOND THE RUGGED EDGE** 

### YOUR TOP CHOICE PARTNER IN INDUSTRIAL COMPUTING FROM THE

### **EDGE TO THE CLOUD**

Established in 2011, Taipei, C&T Solution Inc. is becoming one of the fastest-growing companies in the Industrial Computing Systems field. With its obsession with creating the best rugged edge computers as the core of great industrial leading solutions, C&T has become one of the top enterprises in providing world-class industrial embedded systems.

C&T is a global solutions provider specializing in industrial computer and embedded fields. We are committed to developing and manufacturing rugged edge computers, industrial panel PCs, industrial display systems, and industrial motherboards. C&T strives for the highest standards in innovation and technology to stay ahead of competitors in terms of design, technology, reliability, and versatility.

Our teams have worked strongly and closely with the customers to provide the high-quality and high-value creation of robust embedded computers. Moreover, our engineering specialty and agile manufacturing push the technical boundaries in embedded IoT computers. As a result, C&T is determined to become your top choice partner in industrial computing solutions. Therefore, C&T has an extensive customer base through global network and distribution partners from offices located worldwide.

C&T proudly offers diverse industrial technologies to meet various customers' needs based on their applications and industries. Our application-ready solutions are contributing to escalating advancement in a varied array of industrial sectors, including:

- Industrial Automation
- Transportation
- Food & Beverage
- Military

- Kiosk & Retail
- Security & Surveillance
- Intelligent Healthcare
- Machine Vision & Robotics









#### **OUR MISSION**

C&T is dedicated to creating and delivering world-class technology solutions that empower our clients to reach their business goals. We will apply the highest creativity, integrity, quality, and innovation standards to our products and concepts.





#### **OUR VISION**

Our vision is to create the best rugged edge computers as the core of great solutions that transform people's life. We will relentlessly innovate to deliver world-class edge computers for industry-leading solutions.





#### **OUR SERVICES**

We strive to exceed our customers' expectations with innovative and competitive solutions. For us, this means providing unsurpassed service, delivering premium value, and offering a competitive edge to tour customers. Additionally, our OEM and ODM collaboration constantly aim to deliver high-quality products, reliable partnerships, professional service, and competitive price, service, and competitive price.



We deliver our core brand values through the way we conduct business. C&T's core values of Innovation, Commitment, Collaboration, Agility, and Accountability guide our decisions to exceed expectations.

AGILITY

We are flexible, adaptable, and responsive to the change in demands of our customers, the market, and our environment. We are willing to learn and create new ideas to drive and embrace changes actively.

INNOVATION

We constantly strive to drive innovation into all aspects of our business to provide products that deliver reliability, quality, performance, and value creation.

COLLABORATION

We work together to contribute to the development of new products and services that will ensure the success of our customers.

ACCOUNTABILITY

We always hold ourselves accountable for our products, services, and actions to our employees, customers, and partners.

COMMITMENT

We offer our valued customers the highest possible standards of solutions. At C&T, we treat customers with dignity, respect, and courtesy. We listen objectively to their needs and respond in a timely, efficient, and responsible manner.

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### **INDUSTRIAL COMPUTERS** 12

C&T's fanless embedded systems are extremely flexible and reliable to provide integrated solutions to meet different needs. With its superior features integration, exceptional system performance, flexible I/O connections, wide range power input, smart management functions, and rugged reliability, C&T fanless embedded systems deliver a compelling platform that is needed in today's demanding workloads and industrial needs.

**RUGGED** 

**MACHINE VISION** 

**RCO** 14 **SERIES** 

**VCO** 23

**WATERPROOF** 

**IN-VEHICLE** 

**SERIES** 

**WCO** 

**ACO** 28 SERIES

**FANLESS MINI PC** 

**BCO** 

30

26

**NVIDIA JETSON** JC0 36



#### MODULAR AND RUGGEDIZED EDGE **COMPUTING ACCELERATION**

#### **EDGEBoost** Nodes SERIES

18

20

EDGEBoost Nodes deliver an industrial-grade modular approach for accelerated computing performance at the rugged edge.

**SCALABLE EDGEBOOST I/O MODULE TECHNOLOGY** 

**EDGEBoost** I/O SERIES

EDGEBoost I/O modules are a scalable and modula solution that integrates into C&T's industrial computers and provides enhanced reliability with plug-and-play expandability.





### **INDUSTRIAL PANEL PCS AND TOUCH MONITORS** 42

C&T's Industrial Panel PCs and Touch Monitors are purpose-built for the toughest embedded deployments requiring mission-critical reliability. System integrators and automation engineers can easily deploy C&T industrial panel PCs and touch monitors as human machine interfaces to achieve better productivity and operational efficiency in their enterprise projects.



**DISPLAY MODULE** 

VI0

**IP65 PANEL PC** 

VIO-PC 46

#### **TOUCH MODULE**

VIO-MX	49
SERIES	4/

#### IP66/IP69K

SIO WASHDOWN	50
SIO WASHDOWN FOUCHSCREEN COMPUTER	JU

#### IP66

WIO	51
WATERPROOF	JI

#### **ALL-IN-ONE PANEL PC**

AIO	52
SERIES	52

#### **OPEN FRAME PANEL PC**

HIO	5
SERIES	0.



44

#### **INDUSTRIAL MOTHERBOARDS** 54

C&T offers industrial-grade scalability with standard motherboards and OEM system design. Standard form factors include: Single board computers (1.8" FEMTO-ITX, 2.5" PICO-ITX, and 3.5" SBCs); Mini-ITX; and Micro-ATX.





### **BEYOND THE RUGGED EDGE**

Work-Station Grade Industrial Computer With Intel<sup>®</sup> 12/13/14<sup>th</sup> Gen Processor



DDR5

Up to 64GB 5,600 MT/s

#### Triple 5K Displays

Support up to 8K 2x Display, 1x DVI-I

#### 2x EDGEBoost I/O

Customizable I/O, PoE Ports and M.2 Modules

#### **EDGEBoost Nodes**

Scalable PCIe Gen 4 GPU & NVMe Storages

VCO-6000-RPL Series **Industrial Machine Vision Computer** 



DDR5

Up to 64GB 5.600 MT/s

### **Triple 5K Displays**

Support up to 8K 2x Display, 1x DVI-I

#### Full-Length **Dual GPU**

Support Dual PCle Gen 4.0 GPU

#### Scalable NVMe & **SATA Storage**

Scalable Hot-Swappable SSD Storages

### **WORLD CLASS CERTIFICATION**

UL 62368-1 | EN50155 In-Vehicle Ready Industrial Solutions



### RCO-3000-RPL Series Coming soon VISIT P.15

Small Form Factor Fanless Computer

Intel® 13<sup>th</sup>/12<sup>th</sup> Gen

#### MIL-STD-810G Compliance

50G Shock &

#### 1x EDGEBoost I/O

Customizable I/O, PoE, Ports

#### **Quad 4K Displays**

Support 4K up to 8K 3x DP, 1x DP/HDMI

ECO-1000 Series MEW



Industrial-Grade SuperCAP UPS

8x/16x SuperCAP

200W

Power Output

10-Year

#### 3x Smart Modes

Module or GUI



### **FANLESS** INDUSTRIAL-EDGE COMPUTER

Deployment Ready at the Rugged Edge

Alder Lake N97

Compact Form Factor

**Dual 4K Displays** 

2.5 GbE

**BCO-1000-ADLN** Series







Fanless Mini Computer



**NEXT-GENERATION EDGE AI SOLUTION** 

**NVIDIA JETSON ORIN INDUSTRIAL COMPUTER** 

BCO-3000-RPLS Series WISIT P.31

Small Form Factor Edge Computer

Intel® 12th/13th

10x USB

2.5 GbE



BCO-6000-RPLS Series Fanless Al Edge Computer (VSITP31)







**Expandable GPU** 

**Smart Fan** 

JCO-3000-ORN Series SFF AI Edge Computer VISITE38

JCO-1000-ORN Series

Mini Fanless Al Computer

**Jetson Orin NX** 

10-25W

Jetson Orin Nano

7-15W

Up to 4x 2.5 GbE

**Jetson Orin Nano** 

Up to 40 TOPS

512-1024 CUDA

Cores

LPDDR5

6-Core Arm®

Cortex®-

A78AE



JCO-6000-ORN Series WNEW

Robust Al Edge Computer VISIT P.39

**Jetson Orin AGX** 

LPDDR5

Up to 8x GMSL

4x EDGEBoost I/O

### **UNLEASH THE POWER OF MODULARITY**

Deliver Personalized Performance Upgrade Instantly with the EDGEBoost Series



EDGEBoost I/O SERIES

NEW

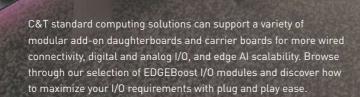
Provide an easy and cost-effective upgrade for the rugged, fanless computer. They elevate computer performance through additional PCIe Gen 4 Expansion, GPU, NVMe, and SATA

storages. EDGEBoost Nodes are more than just performance upgrade, they also equipped

with hardware security features. (Compatible with RCO-6000 Series)

VISIT P.20

Plug and play modular I/O daughterboards for customizable IoT sensor connectivity



/// NEW

PoE | M12 | 10GbE | USB 3 | M.2 | Al | 5G | NVMe

# FANLESS COOLING TECHNOLOGY FOR INDUSTRIAL PCS

Rugged. Reliable. Tested.



# **7Steps**Of Building A Fanless PC

C&T's industrial solutions follow the 7 key steps to build reliable fanless solution that are capable perform real-time processing and machine learning in the harshest edge deployments. Industrial computers help provide the mission-critical foundation to manage new edge AI workloads in key automation deployments with ultimate reliability.



Select A CPU 10W-65WTDP



Utilize Heatsinks
Ultra-Conductive Materials



Select EDGEBoost Nodes
Performance Accelerators



Test And Validate
Ensure Durabillity











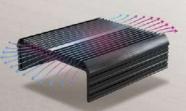




Implement SSDs NVMe SSDs



Use an Extruded
Aluminum PC Case
One-Piece Heatsink Chassis



Put Pieces Together
Ruggedized Design







COMPUTER



COMPUTER



**ACO** SERIES IN-VEHICLE FANLESS COMPUTER



**BCO** SERIES COMPACT INDUSTRIAL COMPUTER



**KCO** SERIES FANNED INDUSTRIAL COMPUTER



JCO SERIES EDGE AI INDUSTRIAL COMPUTER



**ECO** SERIES SUPERCAPACITOR UPS **BACKUP SYSTEM** 



#### **FANLESS DESIGN**

- Prevent failure/repair/ replacement caused by fan part
- Venting holes no longer needed
- Extended MTBF
- No noise



#### **ONE-PIECE DESIGN**

- Robust structure
- Less joint parts and screws for higher shock & vibration tolerance
- · Easy assembly, disassembly, maintenance
- Sealed housing to prevent dust



#### **POWER PROTECTION**

- Over voltage protection
- Over current protection
- Reverse protection



#### **SHOCK & VIBRATION**

RCO & ACO Series comply with MIL-STD 810G on shock & vibration in order to sustain in environment like industrial automation, transportation, military, etc.



#### **EXPANDABLE & MODULARIZATION**

The modular design approach helps with the ease of installation to achieve rapid deployment, and provide wide variety of configurable options to achieve scalability.



#### **EXTENDED OPERATING TEMPERATURE RANGE**

C&T fanless embedded systems support extended temperature to allow applications to function in difficult and harsh environment.



Utilize ultra-conductive materials (copper and aluminum) to accomplish fast heat dissipation through integrated heat pipes and heat sinks. The unique thermal design allows the computers' CPU (up to 35W) to operate without a fan in an extended temperature range



#### INDUSTRY LEADING SAFETY CERTIFICATIONS

Tested and validated with safety certifications ensure product reliability against safety hazards and allow customers to comply with industryspecific regulatory requirements.

















### RCO-1000-EHL SERIES Moreinfo













Model	RCO-1000-EHL-10	RCO-1000-EHL-20	RCO-1000-EHL-30	RCO-1000-EHL-30-2P
CPU Support	Support I	ntel® Atom™ x6425E / Ce	leron® J6413 Processor (	Up to 12W TDP)
Memory	1x 26	0-Pin DDR4 2400/2667/32	200MT/s SO-DIMM. Max.	up to 32 GB
Graphic Output		Dual Independent [	Display by 2x DisplayPort	
1/0	2x RJ45 (2.5 & 1 GbE), 3x USB 3.2 Gen 2 (10 Gbps), 1x USB 2.0 2x RS-232/422/485, 1x Mic-in, 1x Line-out		USB 2.0	
PoE			2x GbE RJ45	
Storage	1x Internal 2.5" SATA HDD Bay (support H=9.5 mm)			nm)
Internal Expansion Slot	1x Full-size Mini PCIe			
Power	9-36 VDC, AT/ATX Select, 3-pin Terminal Block		k	
Operating Temperature	-40°C to 70°C -40°C to 50°C		-40°C to 50°C	
Certification	UL 62368 Ed. 3, CE, FCC Class A CE, FCC Class		CE, FCC Class A	
Dimensions (WxDxH)	150 x 105 x 49 mm		105 x 83 mm	
EDGEBoost I/O Expansion	Up to 1x EDGEBoost I/O	Up to 3x EDGEBoost I/O	Up to 5x EDGEBoost I/O	Up to 3x EDGEBoost I/O

### BCO-1000-EHL SERIES Moreinfo











Model	BC0-1000-EHL-10	BC0-1000-EHL-20	BC0-1000-EHL-30
CPU Support	Support Intel® EHL Processor (Up to 10W TDP) Intel® Celeron® Processor J6413, Quad Core, 1.5 MB Cache, 1.8 GHz		
Memory	1x 260-Pin DDR	4 2400/2667/3200MT/s SO-DIMM. N	Max. up to 32 GB
Graphic Output	Dual Independent Display by 2x DisplayPort		
1/0	2x RJ45 (2.5 & 1 GbE), 3x USB 3.2 Gen 2 (10 Gbps), 1x USB 2.0, 2x RS-232/422/485, 1x Mic-in, 1x Line-out		
Storage	1x Internal 2.5" SATA HDD Bay (support H=9.5 mm)		
Internal Expansion Slot	1x Full-size Mini PCIe		
Power	9-36 VDC, AT/ATX Select, 3-pin Terminal Block		
Operating Temperature	0°C to 50°C		
Certification	UL 62368 Ed. 3, CE, FCC Class A		
Dimensions (WxDxH)	142 x 101.2 x 41.5 mm	142 x 101.2 x 58 mm	142 x 101.2 x 75 mm
EDGEBoost I/O Expansion	Up to 1x EDGEBoost I/O	Up to 2x EDGEBoost I/O	Up to 4x EDGEBoost I/O

### RCO-3000-CML SERIES More info







Model	RC0-3000-CML	
CPU Support	Support 10 <sup>th</sup> Gen Intel <sup>®</sup> CML S Processor	
Memory	2x 260-Pin DDR4 2666/2933MHz S0DIMM. Max. up to 64GB	
Graphic Output	3x DisplayPort (1x DP Port Co-layout HDMI Connector)	
LAN	2x RJ45 [2.5 & 1 GbE]	
1/0	5x RS-232/422/485 (2x internal), 6x USB 3.2 Gen 2, 16x isolated digital I/O, 1x Line-out	
Storage	2x 2.5" SATA HDD bay with RAID 0, 1, 5 support (1x internal; 1x removable & hot-swappable), 1x mSATA	
Internal Expansion Slot	1x Full-size mini-PCIe, 1x M.2 B Key, 1x M.2 E Key	
Power	9-48 VDC, AT/ATX Select, 3-pin Terminal Block	
Certification	UL, CE, FCC Class A, EMC Conformity with EN50155 & EN50121-3-2	
Operating Temperature	-25°C to 70°C	
Dimensions (WxDxH)	192 x 197 x 60.3 mm	
EDGEBoost I/O Expansion	Up to 1x EDGEBoost I/O	

### RCO-3000-RPL SERIES

### intel. Raptor Lake



Model	RCO-3000-RPL	
CPU Support	Support 13 <sup>th</sup> /12 <sup>th</sup> Gen Intel <sup>®</sup> RPL & ADL Processor	
Memory	2x 260-Pin DDR4 3200 MHz SODIMM. Max. up to 64GB	
Graphic Output	4x DisplayPort (1x DP Port Co-layout HDMI Connector)	
LAN	2x 2.5 GbE RJ45	
1/0	5x RS-232/422/485 (2x internal), 6x USB 3.2 Gen 2, 16x isolated digital I/O, 1x Line-out	
Storage	2x 2.5" SATA HDD bay with RAID 0, 1, 5 support (1x internal; 1x removable & hot-swappable), 1x M.2 2242 SATA	
Internal Expansion Slot	2x M.2 B Key, 1x M.2 E Key	
Power	9-48 VDC, AT/ATX Select, 3-pin Terminal Block	
Certification	CE, FCC Class A, EMC Conformity with EN50155 & EN50121-3-2	
Operating Temperature	-25°C to 60°C	
Dimensions (WxDxH)	192 x 227 x 57.6 mm	
EDGEBoost I/O Expansion	Up to 1x EDGEBoost I/O	



### AI EDGE INFERENCE COMPUTER

The RCO-6000 Series is a workstation-grade, fanless computers that incorporates cutting-edge technologies including DDR5, PCIe Gen 4, GPU accelerators, and NVMe storage, ensuring swift and high-performance operations. Ideal for the rigorous demands of Industry 4.0 and edge-native applications, the RCO-6000 Series features a rugged, fanless design and is backed by multiple safety certifications, guaranteeing reliable performance in edge computing environments.







**EDGEBoost Nodes** Support



Scalable NVMe, SATA, and RAID Card



Scalable Robust GPU Cards



### RCO-6000-RPL SERIES More info









aci Laite			
Model	RC0-6000-RPL	RCO-6000-RPL-2E16	
CPU Support	Support 12/13/14 <sup>th</sup> Gen Intel <sup>®</sup> RPL & ADL Processor (LGA 1700, 65W/35W TDP)		
Memory	2x 262-Pin DDR5 4800/5600MHz SC	DIMM. Max. up to 64GB (ECC and Non-ECC)	
Graphic Output	1x DVI-	I, 2x DisplayPort	
1/0	2x 2.5 GbE RJ45, 8x USB 3.2 Gen 2 (10 Gbps), 1x USB 3.2 Gen 1 (Internal), 2x USB 2.0 (internal), 1x Mic-in, 1x Line-out 6x RS-232/422/485 (4x internal), 16x isolated digital I/O		
Storage	2x 2.5" SATA HDD bay with RAID 0, 1 support (1x internal, 1x removable & hot-swappable)		
SIM Socket	2x External SIM socket (Mini PCIE/M.2 B Key attached)		
Power	9-48 VDC, AT/ATX Select, 5-pin Terminal Block		
Operating Temperature	-25°C to 70°C (35W CPU) -25°C to 60°C (65W CPU, i9 CPU Requires an External FAN Kit)		
PCle		RCO-6000-RPL-2E16: 1x PCIe x16 (Gen4), 1x PCIe x1 (Gen3) RCO-6000-RPL-2E8: 1x PCIe x16 (8-lane, Gen4), 1x PCIe x8 (8-lane, Gen4)	
EDGEBoost I/O Expansion	Up to 2x EDGEBoost I/O		

### RCO-6000-CML SERIES More info









Model	RCO-6000-CML	RCO-6000-CML-2C
CPU Support	Support 10 <sup>th</sup> Gen. Intel <sup>®</sup> CML S Processor (LGA 1200, 65W/35W TDP)	
Memory	2x 260-Pin DDR4 2666 /2933	BMHz SO-DIMM, up to 64GB
Graphic Output	1x DVI-I, 2x	DisplayPort
1/0	2x GbE RJ45, 6x USB 3.2 Gen 2, 3x USB 3.2 Gen 1 (1x internal), 2x USB 2.0 header (internal), 1x Mic-in, 1x Line-out 8x RS-232/422/485 (6x internal), 16x isolated digital I/0	
Storage	3x 2.5" SATA HDD bay with RAID 0, 1, 5 support (1x internal; 2x removable & hot-swappable)	
SIM Socket	2x External SIM socket (Mini PCIe attached) (2x External SIM socket : M.2 B Key attached, 5G Module only, Optional)	
Power	9-48 VDC, AT/ATX Select, 5-pin Terminal Block	
Certification	UL 62368 Ed. 3, CE, FCC Class A	
Operating Temperature	-25°C to 70°C (35W/65W CPU)	
EDGEBoost I/O Expansion	Up to 2x EDGEBoost I/O	

### Mix & Match EDGEBoost Nodes Performance Accelerators Upgrade



The AI Edge Inference Computers support modular add-on nodes through a two-piece modular design that allows the EDGEBoost Nodes to easily attach to the lower portion of the RCO-6000-(CML/RPL) for more performance accelerators.

### Top - Compatible RCO-6000 Series RCO-6000-CML RCO-6000-RPL

 Intel<sup>®</sup> 12/13/14<sup>th</sup> Gen ADL/RPL CPU 1x Hotswap SATA SSD (7mm) 1x Internal SATA SSD (9mm) 1x M.2 B Key 2242

EBND-8NVME-S,

EBND-4NVME-S.

EBND-4NVME-H



EBND-2NVME-GPU.

EBND-4NH-1E

• Intel® 10<sup>th</sup> Gen CML CPU 2x Hotswap SATA SSD (7mm) 1x Internal SATA SSD (9mm) 1x M.2 E Key 2230



Bottom - RCO-6000-RPL EDGEBoost Nodes		
PCle Gen 4 GPU Gen 4		
EBND-2-EXP-G4 EBND-2-PWR-G4		
SATA Storage Series		
EBND-2-2SATA-G4, EBND-2-4SATA-G4		
NVMe Series NVMe and GPU Series		
EBND-2-2NVME-G4, EBND-4NVME-GPU,		

ı	PCI/PCIe Expansion	GPU Series
	EBND-2-EXP	EBND-2-PWR
ı	SATA Stora	ge Series
	EBND-2 EBND-2	,
ı	NVMe Series	NVMe and GPU Series
	EBND-8NVME-S, EBND-4NVME-S, EBND-4NVME-H	EBND-4NVME-GPU, EBND-2NVME-GPU, EBND-4NH-1E

Bottom - RCO-6000-CML EDGEBoost Nodes



### **EDGEBoost Nodes Benefits**





0001011

- · Scalable, Expandable, and Flexible.
- Cost Effective Solution
- Faster Time-To-Market
- Quick Upgrade
- Easy Maintenance
- Portable Design
- Future-Proof Technology











Faster Delivery



Easy Maintenance



Future-Proof

#### Bottom - Modular "EDGEboost Nodes" Configurations



- EBND-2-EXP-G4 (RCO-6000-RPL) 1x PCle x16 (Gen 4), 1x PCle x1 (Gen 3) or 2x PCIe x8 [Gen 4]
- EBND-2-EXP [RCO-6000-CML] PCIe x16/ PCI Expansions



- EBND-2-PWR-G4 (RCO-6000-RPL) 1x PCle x16 (Gen 4), 1x PCle x1 (Gen 3) or 2x PCle x8 (Gen 4)
- 12~48VDC Power Supply (280W) EBND-2-PWR (RCO-6000-CML)
- PCIe x16/ PCI Expansions 12~48VDC Power Supply (280W)



 EBND-2-2SATA 2x Hot-Swap 2.5" SATA Drives (15mm) RAID 0, 1, 5, 10



EBND-2-4SATA

4x Hot-Swap 2.5" SATA Drives (7mm) RAID 0, 1, 5, 10



 EBND-2-2NVME-G4 (RCO-6000-RPL only) 2x Hot-Swap 2.5" NVMe SSD Bay [15mm] PCIe Gen 4 Expansion



EBND-8NVME-S 8x Hot-Swap 2.5" U.2 NVMe Drives (7mm)

Hardware RAID 0, 1, 5, 6, 10



4x Hot-Swap 2.5" U.2 NVMe Drives (15mm) **RAID 0.1** 



RAID 0, 1

4x Hot-Swap 2.5" U.2 NVMe Drives (15mm)



EBND-4NVME-GPU 1x GPU Expansion 4x Hot-Swap 2.5" U.2 NVMe Drives (7mm)



EBND-2NVME-GPU 1x GPU Expansion 2x Hot-Swap 2.5" U.2 NVMe Drives (15mm)



 EBND-4NH-1E 1x PCIe x8 Slot Hardware RAID 0, 1, 5, 6, 10 4x Hot-Swap 2.5" U.2 NVMe Drives (7mm)



C&T supports rich expandability to boost wireless connectivity, streamline integration and unlock automation capabilities in harsh deployments. Leading edge and legacy technologies are easily incorporated into a powerful, intelligent IoT solution for better bandwidth and I/O flexibility. Our daughterboard modules integrate easily into C&T embedded and edge computers through standard PCIe protocols. These add-in modules include additional ethernet I/O ports in 1GbE (RJ45 & M12), 10GbE (RJ45), USB 3.2 Gen1, and 5G ready M.2 for scalable connectivity in IoT deployments at the edge.



EBIO-4ETH	EBIO-4ETH-M12	EBIO-4LAN	EBIO-4LAN-M12	EBIO-D10G
Intel® Ethernet Controller I350  1x PCle x4 Gold finger [x4 Lane]  4x 1GbE LAN, RJ45 Port  Support Power over Ethernet by an optional PoE module	Intel® Ethernet Controller I350  1x PCle x4 Gold finger (x4 Lane)  4x 1GbE LAN, M12 Port  Support Power over Ethernet by an optional PoE module	Intel® Ethernet     Controller I210     1x PCIe x1 Gold finger     4x 1GbE LAN, RJ45 Port     Support Power over     Ethernet by an optional     PoE module	Intel® Ethernet     Controller I210-AT     1x PCIe x1 Gold finger     4x 1GbE LAN, M12 Port     Support Power over     Ethernet by an optional     PoE module	Intel® Ethernet Controller X710-AT2  1x PCIe x1 Gold finger (x4 Lane)  2x 10GbE LAN, RJ45 Port
EBIO-4ETH-POE	EBIO-4ETH-POE-M12	EBIO-4LAN-POE	EBIO-4LAN-POE-M12	

### **EDGEBoost I/O Boosting Flexibility at the Edge**







Edge Al / Storage				
EBIO-2M2BK	EBIO-M2MK	EBIO-M2BK		
<ul> <li>2x M.2 B Key for AI/5G/NVMe module</li> <li>2x M.2 B Key slot, Support 2x AI/5G Module (Support 1x 5G Only)</li> <li>M.2 B Key, PCIe x2, 2242/3042/3052</li> <li>1x SIM slot</li> <li>Support 1x Universal Slot Only</li> </ul>	<ul> <li>1x M.2 M Key for Al/NVMe module (PCIe x4)</li> <li>M.2 M Key slot, Support Al/NVMe Module</li> <li>M.2 B Key, PCIe x4, 2242/2260</li> <li>Support 1x Universal Slot Only</li> </ul>	<ul> <li>M.2 B Key for 5G module</li> <li>2x SIM slot</li> <li>1x SIM Switch</li> <li>Support 1x Universal Slot Only</li> </ul>		











Digital & Analog I/O				
EBIO-HDMI	EBIO-DP-DIO	EBIO-2COM	EBIO-4USB	EBI0-4U3
	• 4x USB 3.0, Type-A Ports			
• 1x HDMI Port (Full-HD)	• 1x DP (4K UHD), 1x DIO (4 in / 4 out, Isolated)	• 2x COM Ports	4x USB 2.0, Type A Ports (with USB hub)	

### **EDGEBoost I/O SERIES**

### Compatible Industrial Computers











COMPATIBLE LIST	ACO-6000 (CML / KBL)	RCO-6000 (RPL/CML/CFL)	RCO-3000 (CML/CFL)	RCO-1000 (EHL/J1900)	BCO-1000 (EHL / J1900)
EBIO-2M2BK	CML     KBL: AI/NVMe only	•	CML     CFL: AI/NVMe only		
EBIO-M2MK	•	•	•		
EBIO-M2BK	• CML • KBL: AI/NVMe only	•			
EBIO-4U3	•	•	•		
EBIO-D10G	•	•	•		
EBIO-4ETH	•	•	•		
EBIO-4ETH-POE	•	•			
EBIO-4ETH-M12	•	•	•		
EBIO-4ETH-M12-POE	•	•			
EBIO-4LAN		•			
EBIO-4LAN-POE		•			
EBIO-4LAN-M12		•			
EBIO-4LAN-POE-M12		•			
EBIO-HDMI				•	•
EBIO-DP-DIO				•	•
EBIO-2COM				•	•
EBI0-4U3				•	•

Coming soon

### **DCO-1000** SERIES

#### **INDUSTRIAL-GRADE DIN RAIL COMPUTER**

C&T offers DIN Rail mountable computers that are available in various configurations. You can configure your DIN rail PC with the CPU, Memory, Storage, I/O Ports, and Operating System that you want. DIN rail industrial PCs can be easily and quickly mounted to a standard DIN rail.

- World Class Certifications C1D2, ATEX Zone 2, UL, FCC Class B
- Rich I/O Configurations
- Compact & Slim Form Factor



### intel

Model	DC0-1000-ASL	DC0-1000-ORN	
CPU Support	Intel® Atom® Processor x7425E, Quad Core, 6 MB Cache, HFM 1.5 GHz, TDP 12W Intel® Atom® Processor x7211E, Dual Core, 6 MB Cache, HFM 1.0 GHz, TDP 6W	NVIDIA <sup>®</sup> Jetson Orin™ Nano 4/8GB GPU with 32 Tensor Cores	
Memory	1x 262-Pin DDR5 4800MHz SODIMN	1. Max. up to 32 GB (ECC/Non-ECC)	
Graphic Output	Dual Independent Display by 2x Displ	ayPort 1.4, DP++ (4096 x 2160@60Hz)	
LAN	4x 2.5 G	4x 2.5 GbE LAN	
1/0	2x RS-232/422/485, 2x USB 3.2 Gen 2 (10 Gbps), 2x USB 3.2 Gen 1 (Shared PCIe Gen 2 x1 Lane bandwidth), 4 in / 8 out (Isolated)		
Storage	1x M.2 (B Key, 3042/3052, PCIex 1 + USB 3.2 Gen2, Support 4G/5G, SATA Module)		
Power	9-36 VDC, AT/ATX, 3	-pin Terminal Block	
Operating Temperature	-40°C t	to 70°C	
Certification	CE, FCC Class B, UL	., C1D2, ATEX Zone2	
Dimensions (WxDxH)	150 x 105 x 49 mm		
Mounting	DIN-Rail Mounting, Wall Mounting (Optional)		



MACHINE VISION COMPUTERS

POWERFUL AI VISION AT THE RUGGED EDGE



### **WORKSTATION-GRADE INDUSTRIAL MACHINE VISION COMPUTER**

The VCO-6000 Series is engineered for seamless integration of dual FHFL GPU cards through PCIe Gen 4 and industry-leading external storage expansion drives, delivering optimized processing and data aggregation. Deploy machine vision and AI inference applications with utmost reliability and performance to the rugged edge.



Dual GPU Support



PCIe Gen 4 Expansions



Scalable NVMe & SATA Storage



Shock & Vibration Resistance

### VCO-6000-RPL SERIES Moreinfo







VCO SERIES





Model	VCO-6000-RPL-3E	VCO-6000-RPL-4E	
	3x PCIe Expansion Slots		
CPU Support	Support 12/13/14 <sup>th</sup> Gen Intel <sup>®</sup> RPL & ADL Processor (LGA 1700, 65W/35W TDP)		
Memory	2x 262-Pin DDR5 4800/5600MHz SODIMM. Max. up to 64GB (ECC and Non-ECC)		
Graphic Output	1x DVI-I, 2x	DisplayPort	
LAN	2x 2.5 GbE RJ45 (Suppor	t Wake-on-LAN and PXE)	
1/0	4x USB 3.2 Ge 5x USB 3.2 Gen 1 (Internal), 1x l 6x RS-232/422/485 (4x interna	USB 3.2 Gen 1 header (internal)	
Storage		support (1x Internal, 1x Removablel) 1x Mini PCI Express)	
SSD/HDD	<ul> <li>optional:</li> <li>4B7M: 4x Removable 2.5" SATA HDD Bay (support H=7mm, Hot-swappable, Optional) Support RAID 0</li> <li>2B15M: 2x Removable 2.5" SATA HDD Bay (support H=15mm, Hot-swappable, Optional) Support RAID</li> <li>2N15M: 2x Removable 2.5" U.2 NVMe Bay (support H=15mm, Hot-swappable, Optional) Support RAID</li> </ul>		
Internal Expansion Slot	1x Full-size Mini PCIe ( 1x M.2 B Key, 2	1x shared by 1x mSATA) 242/3042/3052	
Power	AT/ATX Select 5-pin Terminal Block, 9-48 VDC 4-pin Terminal Block, 12~48VDC for GPU Card (optional)		
Audio	Line-out / Mic-in Ph	none Jack (internal)	
Operating Temperature	-25°C to 70°C (35W CPU) -25°C to 60°C (65W CPU)		
Dimensions (WxDxH)	157 x 340 x 240 mm	177 x 340 x 240 mm	
PCIe	1x PCIe x16 (Gen4) 2x PCIe x1 (Gen3)	2x PCIe x16 Slot (x8 Lane, Gen 4) 1x PCIe x4 (x1 Lane, Gen 3)	

### VCO-6100 SERIES More info













Coffee Lake R	-				
Model	VCO-6122	VCO-6133	VCO-6144	VCO-6155	
	With two PCI or PCIe expansion slot	With three PCI or PCIe expansion slot	With four PCI or PCIe expansion slot	With five PCI or PCIe expansion slot	
CPU Support	Support 8 <sup>th</sup> /9 <sup>th</sup> Gen. Intel <sup>®</sup> CFL-R S Processor (LGA 1151, 65W/35W TDP) Core <sup>™</sup> i7-9700E/9700TE/8700T, Core <sup>™</sup> i5-9500E/9500TE/8500T, Core <sup>™</sup> i3-9100E/9100TE/8100T, Pentium <sup>®</sup> G5400T, or Celeron <sup>®</sup> G4900T			E/8500T,	
Memory	2x 260-pin DI	DR4-2400/2666MHz SO-I	DIMM, up to 64GB (Un-buffe	red and Non-ECC)	
Graphic Output		1x DVI-	, 2x DisplayPort		
LAN		2x GbE RJ45 (Supp	ort Wake-on-LAN and PXE)		
1/0	4x USB 3.2 Gen 2, 6x internal USB 3.2 Gen1 (5 Gbps), 6x RS-232/422/485 (4x internal), 16x isolated digital I/O				
Storage	2x Internal 2.5" SATA HDD Bay (Support H=9mm) 2x Removable 2.5" SATA HDD Bay (Support H=7mm, Hot-swappable) Support RAID 0, 1, 5, 10 1x mSATA (shared by 1x Mini PCIe), 1x NVMe M.2 M Key			Support RAID 0, 1, 5, 10	
Internal Expansion Slot	2)	Full-size mini-PCIe (1	shared by 1x mSATA), 1x M.2	? E Key	
Power		9-48 VDC, AT/ATX S	Select, 3-pin Terminal Block	ck	
Audio		Line-out / Mic-i	n Phone Jack (internal)		
Operating Temperature			70°C (35W CPU) 60°C (65W CPU)		
Dimensions (WxDxH)	137 x 340 x 240 mm	157 x 340 x 240 mm	177 x 340 x 240 mm	197 x 340 x 240 mm	
Weight	8.5 Kg	9.1 Kg	9.5 kg	10.1 kg	
PCI & PCI Express	<ul> <li>VCO-6122E: 2x PCIe x8</li> <li>VCO-6122P: 2x PCI</li> <li>VCO-6122C: 1x PCIe x16 1x PCI</li> </ul>	<ul> <li>VCO-6133E: 2x PCIe x1 1x PCIe x16</li> <li>VCO-6133P: 3x PCI</li> <li>VCO-6133C: 1x PCIe x16 2x PCI</li> </ul>	VCO-6144P:     4x PCI      VCO-6144C:     2x PCIe x4     1x PCIe x16 (8-lane)     1x PCI	VCO-6155C:     2x PCIe x4     1x PCIe x16 (8-Lane)     2x PCI	



The WCO Series expands the limitation of hardware to environment where the normal embedded computer are not suitable to be used. The WCO computers are a great solution for food and beverage processing, outdoor digital signage, surveillance, Military & defense, and automation control where the computers are in constant threat of water splash from all directions to even water immersion.



IP67/IP69K Rating



Wide Range Voltage 9-36V or 48-110V



Ports



High-Quality **Compact Construction** 



### WCO-3000-EHL SERIES More info







Model	WC0-3000-EHL
CPU Support	Intel® Celeron® Processor J6413, Quad Core, 1.5 MB Cache, 1.8 GHz, TDP 10W
Memory	1x 260-Pin DDR4 2400/2667/3200MT/s SODIMM.  Max. up to 32 GB (In-Band ECC/non-ECC)
Graphic Output	1x DisplayPort 1.4, DP++ (4096 x 2160@60Hz) or 1x HDMI (Optional)
1/0	2x RJ45 by M12 X-Code, 2x USB 3.2 Gen 2 Type A (Waterproof), 1x RS-232/422/485 by M12 A-Code
Storage	1x Internal 2.5" SATA HDD Bay, 1x mSATA (shared by 1x Mini PCI Express)
Expansion	1x M.2 (B Key, 3042/3052, PCIe x 1 + USB 3.2 Gen2, Support 4G/5G/Hailo Al Module), 2x External SIM socket, 1x Full-size Mini PCIe
Power	DC IN 9~36 V, DC IN 48~110V (Optional), M12 S-code 4-pin
Certification	IP69K, CE, FCC Class A, E-Mark
Operating Temperature	-40 °C to 60 °C
Dimensions (WxDxH)	231 x 292 x 57 mm



### **DELIVER INTELLIGENCE AT THE MOBILE EDGE**

The ACO-6000 Series offers robust, fanless in-vehicle computers, rigorously tested for mission-critical automotive applications. Essential for intelligent transportation, these systems adeptly handle edge data processing for machine learning and intelligence. With the need for highperformance computing in vehicles, they efficiently process data from various sensors and IoT devices, ensuring swift, low-latency communication.



Scalable 16x PoE



EN50155 EN50121-3-2



Wide Power Range 9-48V and 48-110V



MIL-STD-810G Compliant Method 514 & 517



### ACO-6000-CML SERIES More info









Model	ACO-6000-CML	ACO-6000-CML-1E	
CPU Support	Support 10 <sup>th</sup> Gen Intel <sup>®</sup> CML S Processor (LGA 1200, 65W/35W TDP) Xeon <sup>®</sup> W-1290TE/1270TE/1250TE, Core <sup>™</sup> i9-10900E/10900TE, Core <sup>™</sup> i7-10700E/10700TE, Core <sup>™</sup> i5-10500T/10500TE, Core <sup>™</sup> i3-10100T/10100TE		
Memory	2x 260-Pin DDR4 2666 /2933MHz S0-I	DIMM, up to 64GB (ECC and Non-ECC)	
Graphic Output	1x DVI-I, 2x	DisplayPort	
1/0	2x GbE RJ45, 6x USB 3.2 Gen 2, 3x USB 3.2 Gen 1 (1x internal), 2x USB 2.0 header (internal), 8x RS-232/422/485 (6x internal), 8x DI + 8x D0 with isolation, Line-out / Mic-in Phone Jack		
Storage	3x 2.5" SATA HDD bay with RAID 0, 1, 5 support (1x internal; 2x removable & hot-swappable)		
Internal Expansion Slot	2x Full-size mini-PCle, 1x M.2 (E Key, PCle x2, 2230, USB 2.0, Support CNVi)		
Power	9-48VDC, 5-pin Terminal Block. 48~110VDC (Optional), 3-pin Terminal Block. AT/ATX Select		
Operating Temperature	-25°C to 70°C (	35W/65W CPU)	
Certification	E-Mark, EMC Conformity wi	ith EN50155 & EN50121-3-2	
Dimensions (WxDxH)	240 x 261 x 79 mm	240 x 261 x 127 mm	
Universal Expansion Slot	2 (by mini PCIe interface)	4 (by mini PCIe interface)	
PCI & PCI Express		ACO-6000-CML-1E: 1x PCIe x16 ACO-6000-CML-1I: 1x PCI (Optional)	
EDGEBoost I/O Expansion Up to 2x EDGEBoost I/O		Up to 4x EDGEBoost I/O	

### ACO-6000-RPL SERIES

### intel.

Raptor Lake Alder Lake





Model	ACO-6000-RPL	ACO-6000-RPL-1E				
CPU Support	Support 12/13/14 <sup>th</sup> Gen Intel <sup>®</sup> RPL & ADL Processor (LGA 1700, 65W/35W TDP)					
Memory	2x 262-Pin DDR5 4800/5600MHz SODIMM. Max. up to 64GB (ECC and Non-ECC)  1x DVI-I, 2x DisplayPort  2x 2.5 GbE RJ45, 8x USB 3.2 Gen 2 (10 Gbps), 1x USB 3.2 Gen 1 (Internal), 2x USB 2.0 (internal), 1x Mic-in, 1x Line-out, 6x RS-232/422/485 (4x internal), 16x isolated digital I/O  2x 2.5" SATA HDD bay with RAID 0, 1 support (1x internal, 1x removable & hot-swappable) 9-48VDC, 5-pin Terminal Block. 48~110VDC (Optional), 3-pin Terminal Block. AT/ATX Select			2x 262-Pin DDR5 4800/5600MHz SODIMM. Max. up to 64GB (ECC and Non-ECC)		
Graphic Output						
1/0						
Storage						
Power						
Temperature	-25°C to 70°C (	35W/65W CPU)				
Certification	Full EN50155 Railway Certification, CE, FCC					
PCI & PCI Express	ACO-6000-RPL-1E: 1x PCIe x16					
EDGEBoost I/O Expansion						



### **COMPACT INDUSTRIAL COMPUTER**

The BCO Series are designed and built to withstand deployment in challenging environments, managing workloads at the rugged edge for processing, storage, connectivity, and machine learning. Available in three series, the BCO-1000, BCO-3000, and BCO-6000 Series are capable of accommodating various edge workloads from power efficient computers to scalable GPU computers.







Support Expandablee GPU



Fast Time To Market



Compact & Ruggeddized Design



#### **BCO-1000-ADLN**

FANLESS MINI COMPUTER

#### **BCO-3000-RPLS**

SMALL FORM FACTOR EDGE COMPUTER















Alder Lake		.0	
Model	BCO-1000-ADLN	BCO-3000-RPLS	BCO-6000-RPLS
CPU Support	12 <sup>th</sup> Gen Intel <sup>®</sup> IoTG Alder Lake-N Processor N97, QC, 12W	Core i9/i7/i5/i3, Pentium, Celeron (35W only)  Intel® Q670E Express Chipset	
System Chipset	Within processor		
Memory	1 x DDR5 SO-DIMM slot (262-pin)		
Graphic Output	1 x HDMI 1.4b 1 x DisplayPort 1.4a	1 x HDMI 1.4b 2 x Dual Mode DisplayPort 1.4a	
LAN	2 x Intel <sup>®</sup> I225-V 2.5GbE LAN	3x 2.5G	bE LAN
1/0	2x DB9 COM, 6 x USB 3.2 Gen 2 x 1 Type-A, Line-in/Line-out/Mic-in, 1 x 8 GPI0	4x DB9 COM, 8 x USB 3.2 Gen 2 x 1 Type-A, 2 x USB 2.0 Type-A, 1 x 1*2-port Audio-jack connector for Line-out/Mic-in, 8 in / 8 out (Isolated)	
Storage	1 x M.2 B Key slot (2242/ 2280/ 3042)	1 x M.2 M key T	ype: 2242/2280
Internal Expansion Slot	1 x M.2 E Key slot [2230], 1 x M.2 B Key slot [2242/ 2280/ 3042]	1 x M.2 E key	ype: 2242/2280, y Type: 2230, 2 with Nano SIM Holder
PCI Express			2x PCIe x8 Slot or 1x PCIe x16 Slot (New Board)
Power	AT/ATX 9~36VDC, 3-pin Terminal Block		936 (New Board), -pin Terminal Block
Audio	Line-in/Line-out/Mic-in	THE FITT LIBES A FIMIT LONGORMITY WITH FINALITAD & FINALITY I = 3 - 7	
Operating Temperature			
Certification	CE, FCC Class A, EMC Conformity with EN50155 & EN50121-3-2		
Dimensions (WxDxH)	192 x 140 x 67.5 mm		



BCO-2000 SERIES More info







- Support 8<sup>th</sup> Gen. Intel<sup>®</sup> Core™ i5 & Intel<sup>®</sup> Celeron® Processor
- TPM 2.0 Supported
- UL Listed

- Support AMD Ryzen™ Embedded R1000/V1000 Series Processor
- TPM 2.0 Supported
- UL Listed









Model	BCO-2000-WHL-U	BCO-2000-RYZ-V1605B	BCO-2000-RYZ-R1606G	
	Basic Fanless System ideal for space-constrained applications	Basic Fanless System ideal for space-constrained applications		
CPU Support	Support 8 <sup>th</sup> Gen. Intel® WL-UE Processor Intel® Core™ i5-8365UE or Intel® Celeron® 4305UE Processor	AMD Ryzen™ Embedded V1605B with Radeon™ Vega 8 Graphics, 4M Cache, 4 Cores, 8 Threads, Up to 3.6 GHz	AMD Ryzen™ Embedded R1606G with Radeon™ Vega 3 Graphics, 4M Cache, 2 Cores, 4 Threads, Up to 3.5 GHz (Optional)	
Memory	1x 260-Pin DDR4 2400MHz S0-DIMM, up to 32GB	2x 260-Pin DDR4 2400 M	IHz SO-DIMM. Max 32 GB	
Graphic Output	1x DisplayPort, 1x HDMI (Optional)	1x DisplayPort, 1x 24-bit dual cl	hannel LVDS, 1x HDMI (Optional)	
LAN	2x	RJ45 GbE (Support Wake-on-LAN and	PXE)	
USB, Serial	4x USB 3.2 Gen 2, 2x USB 2.0 header (internal), 2x RS-232/422/485		s), 4x USB 2.0 (2x internal), 2/422/485	
Storage	1x mSATA (shared by 1x Mini PCIe), 1x Internal 2.5" SATA HDD Bay	1x M.2 B Key, 3042, Support SATA, 1x Internal 2.5" SATA HDD Bay (support H=9.5mm)		
Internal Expansion Slot	2x Full-size Mini-PCIe (1x shared with mSATA)	(PCIe x1 & USB 3.0, 3042/305)	1x M.2 B Key (PCIe x1 & USB 3.0, 3042/3052, SATA, USIM, Support 4G/5G) 1x Full-Size Mini PCIe for expansion modules	
Power	AT/ATX 12V Select, 3-pin Terminal Block	AT, ATX	( 12VDC	
Audio	Line-out / Mic-in Internal			
Operating Temperature	-20°C to 60°C	-20°C to 55°	C (25W CPU)	
Certification		UL 62368 Ed. 3, CE, FCC Class A		
Dimensions		140 (W) x 192 (D) x 61 (H) mm		
Weight	1.4 kg	1.5 kg		
Universal Expansion Slot		Up to 2x Universal Expansion		
Expansion (Option)	<ul> <li>2x LAN</li> <li>2x PoE</li> <li>2x COM</li> <li>2x USB 2.0</li> <li>4x COM</li> <li>2x USB 3.2 Gen1</li> </ul>		ort 1x Universal Slot Only) (Support 1x Universal Slot Only)	



### **FANNED INDUSTRIAL COMPUTER FOR INSPECTION & INTELLIGENT COMPUTER VISION**

Introducing the KCO-RPL Series, a line of high-performance fanned industrial computers powered by Intel's latest 13th Gen Raptor Lake processor. These ruggedized edge computers deliver extensive scalability and IIoT-centric flexibility for seamless optimization in high-spec deployment applications. Additionally, the KCO-RPL Series provides a number of edge-native features to accommodate and ensure reliable performance at the rugged edge.



Support Dual FLFH GPU



Rich I/O



Internal Power Supply Unit



Rackmountable Industrial Solution

#### **CERTIFICATION READY INDUSTRIAL COMPUTERS**

### **KCO-2000** SERIES

intel

Certification-ready industrial computers are embedded computing solutions that serve as key building blocks for enterprise and IoT applications that require processing. The KCO Series of industrial computers is a commercial off-the-shelf (COTS) computing solution that provides reliability, regulatory safety, and embedded longevity with C&T's extended lifecycle support. These certification-ready industrial computers are deployable in IoT applications in markets for kiosks, ATMs, security and surveillance, metrology and automation inspection, and mobile medical carts.

KCO-2000-CFL Coffee Lake R KCO-2000-RPL Raptor Lake / Alder Lake





Model	KCO-2000-CFL	KC0-2000-RPL
	Certification-Ready Industrial Computer with LGA- 1151 socket for Intel <sup>®</sup> CFL-R S Processor	Industrial Computer with 2U Certification-Ready, 12 <sup>th</sup> /13 <sup>th</sup> Gen Intel <sup>®</sup> Core <sup>®</sup> Processor
CPU Support	Support 8 <sup>th</sup> /9 <sup>th</sup> Gen Intel <sup>®</sup> CFL-R S Processor (LGA 1151, 35W TDP)	Support 12 <sup>th</sup> /13 <sup>th</sup> Gen Intel <sup>®</sup> Core <sup>™</sup> i9/i7/i5/i3 Alder lake-S, Raptor Lake-S Processor (LGA 1700, 65W Max TDP)
Memory	4x 288-Pin DDR4 2133/2400/2666MHz DIMM. Max. up to 128GB	4x DDR4 2133/2400/2666MHz DIMM. 128 GB Max
Graphic Output	1x VGA,1xDVI, 2x DP	4x DP++
LAN	GbE1: Intel I219LM (Support Wake-on-LAN and PXE) GbE2: Intel I210-AT (Support Wake-on-LAN and PXE)	GbE1: Intel® I219LM (Support Wake-on-LAN and PXE) GbE2: Intel® I225-V (Support Wake-on-LAN and PXE)
USB & Serial	2x RS-232/422/485 + 2x RS-232 2x RS-232 (internal header) 6x USB 3.2 Gen1 (5 Gbps) 7x USB 2.0	6x USB 3.1 Gen 2 (10 Gbps) 1x USB 3.2 Gen 2x2 (20 Gbps) Type C 6x RS-232 1x 8-bit DIO (4-in/4-out)
Storage	1x Hot-Swappable 2.5" SATA Drive Bay (support H=7mm) 1x M.2 (M Key, NVMe PCIe x4, 2280) 1x M.2 (E Key, PCIe x2, USB 2.0, 2230)	1x M.2 M / NVMe PCle x 4 / 2242, 2260, 2280 1x M.2 M / NVMe PCle x 4 / SATA / 2242, 2260, 2280 1x M.2 E / PCle x2 / USB 2.0 / 2230
Internal Expansion Slot	1x PCIe x16 slot (low profile, up to 9" card length)	1x PCIe x16 Slot (Gen 5) 2x PCIe x4 Slot (Gen 4, Open End) 1x PCIe x16 Slot (Gen 3, 4-Lane)
Power	AT, ATX Internal 250W Flex Power Supply	ATX ACPI 5.0 compliant
Audio	Line-out / Mic-in Phone Jack	1x Mic-in, 1x Line-in, 1x Line-out
Operating Temperature	0°C to 35°C	0°C to 60°C
Dimensions (WxDxH)	12.73" x 10.75" x 3.45"	12.73" x 10.75" x 3.45"
Weight	11 lbs (barebone w/ cha	assis, mb, and PSU only)
Certifications CE, FCC, UL Certified		JL Certified

### **KCO-3000** SERIES

KCO-3000-CFL Coffee Lake R KCO-3000-RPL Raptor Lake / Alder Lake





### intel.

Model	KCO-3000-CFL	KCO-3000-RPL	
	Certification-Ready Industrial Computer with LGA- 1151 socket for Intel® CFL-R S Processor	Industrial Computer with 3U Certification-Ready, 12 <sup>th</sup> /13 <sup>th</sup> Gen Intel <sup>®</sup> Core <sup>®</sup> Processor	
CPU Support	Support 8 <sup>th</sup> /9 <sup>th</sup> Gen Intel <sup>®</sup> CFL-R S Processor (LGA 1151, 35W TDP)	Support 12 <sup>th</sup> /13 <sup>th</sup> Gen Intel <sup>®</sup> Core <sup>™</sup> i9/i7/i5/i3 Alder lake-S, Raptor Lake-S Processor (LGA 1700, 65W Max TDP)	
Memory	4x 288-Pin DDR4 2133/2400/2666MHz DIMM. Max. up to 128GB	4x DDR4 2133/2400/2666MHz DIMM. 128 GB Max	
Graphic Output	1x VGA,1xDVI, 2x DP	4x DP++	
LAN	GbE1: Intel I219LM (Support Wake-on-LAN and PXE) GbE2: Intel I210-AT (Support Wake-on-LAN and PXE)	GbE1: Intel® I219LM (Support Wake-on-LAN and PXE) GbE2: Intel® I225-V (Support Wake-on-LAN and PXE)	
USB & Serial	2x RS-232/422/485 + 2x RS-232 2x RS-232 (internal header) 6x USB 3.2 Gen1 (5 Gbps) 7x USB 2.0	6x USB 3.1 Gen 2 (10 Gbps) 1x USB 3.2 Gen 2x2 (20 Gbps) Type C 6x RS-232 1x 8-bit DIO (4-in/4-out)	
Storage	1x 3.5" SATA HDD drive or 2x 2.5" SSD/HDD up to 15mm 1x M.2 (M Key, NVMe PCIe x4, 2280) 1x M.2 (E Key, PCIe x2, USB 2.0, 2230)	1x M.2 M / NVMe PCIe x 4 / 2242, 2260, 2280 1x M.2 M / NVMe PCIe x 4 / SATA / 2242, 2260, 2280 1x M.2 E / PCIe x2 / USB 2.0 / 2230	
Internal Expansion Slot	1x PCIe x16 full height, up to 10" card length) 1x PCIe x4, 1x PCIe x4	1x PCIe x16 Slot (Gen 5) 2x PCIe x4 Slot (Gen 4, Open End) 1x PCIe x16 Slot (Gen 3, 4-Lane)	
Power	AT, ATX Internal 300W Flex Power Supply	ATX ACPI 5.0 compliant	
Audio	Line-out / Mic-in Phone Jack	1x Mic-in, 1x Line-in, 1x Line-out	
Operating Temperature	0°C to 45°C	0°C to 60°C	
Dimensions (WxDxH)	13.15" x 11.78" x 5.23"	13.15" x 11.78" x 5.23"	
Weight	12.5 lbs (barebone w/ chassis, mb, and PSU only)		
Certifications	CE, FCC, UL Certified		

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### **NEXT-GENERATION EDGE AI COMPUTING SOLUTION**

The JCO Series industrial computer, powered by the advanced NVIDIA Jetson platform, is a standout in Al and industrial computing. This series offers exceptional AI computing capabilities, making it perfect for sophisticated robotics, autonomous machinery, and high-end embedded Al tasks. Designed to withstand harsh industrial conditions, the JCO Series ensures consistent performance even in extreme environments.



EDGEBoost I/O Support



Rich I/O Configuration



World-Class Certification



Ruggedized Fanless Solution

### JCO-1000

Ultra Compact





#### **Jetson Orin Nano**

Series

Jetson Orin Nano series modules deliver up to 40 TOPS of AI performance in the smallest Jetson form-factor, with power options between 7W and 15W. This gives you up to 80X the performance of NVIDIA Jetson Nano. Jetson Orin Nano is available in 8GB and 4GB versions.

### JCO-3000

Slim Advanced





#### **Jetson Orin NX**

Jetson Orin NX modules deliver up to 100 TOPS of Al performance in the smallest Jetson form factor, with power configurable between 10W and 25W. This gives you up to 3X the performance of Jetson AGX Xavier and up to 5X the performance of Jetson Xavier NX. Jetson Orin NX is available in 16GB and 8GB versions.

### JCO-6000

High Performance





#### **Jetson AGX Orin**

Jetson AGX Orin modules deliver up to 275 TOPS of Al performance with power configurable between 15W and 60W. This gives you up to 8X the performance of Jetson AGX Xavier in the same compact form factor. Jetson AGX Orin is available in 64GB ,32GB, and Industrial versions.

JCO SERIES

# NVIDIA JETSON ORIN INDUSTRIAL COMPUTER

### JCO NVIDIA® JETSON ORIN™ SERIES

JCO-1000 SERIES

MINI FANLESS AI COMPUTER

SFF AI EDGE

JCO-3000 SERIES SFF AI EDGE COMPUTER









Model	JCO-1000-ORN JCO-3000-ORN-A		JC0-3000-ORN-B	
CPU Support	NVIDIA® Jetson Orin™ Nano 4/8GB GPU with 32 Tensor Cores			
Graphic Output		1x HDMI		
LAN	1 x GbE LAN	2 x GbE LAN	4x RJ45 (Support 4x PoE, Optional)	
1/0	2x RS-232/422/485, 4 in / 4 out (Isolated), 2x USB 3.2 Gen 2 (10 Gbps), 2x USB 2.0, 1x USB Type-C (For OS Flash)  2x RS-232 or 485 (internal, Switch by Jumper), 4x USB 3.0 ( Shared with USB 3.2 Gen 2 Hub), 4 in / 4 out (Isolated), 1x Micro USB (OTG)		2x RS-232/485 (Internal, switch by Jumper), 4x USB 3.0 ( Shared with USB 3.2 Gen 2 Hub), 8 in / 8 out (Isolated), 1x USB Type-C (For OS Flash)	
Storage	1x M.2 (M Key, 2242/2280, PClex 4, Support NVMe)			
Expansion	1x M.2 (B Key, 3042/3052, USB 3.2 Gen1, Support 4G/5G) 1x M.2 (E Key, 2230, PCIe x1, USB 2.0, Support Wi-Fi/Bluetooth)			
Power	AT/ATX 9~36VDC, 3-pin Terminal Block	AT 12~24VDC, 3-pin Terminal Block	AT/ATX 12-24VDC, 3-pin Terminal Block	
Operating Temperature	-25°C to 70°C	-20°C to 55°C (2 -20°C to 60°C (15	25W, NX Module) 5W, Nano Module)	
Certification	CE, FCC Class B, UL	CE/FCC/UL	CE/FCC/UL/EMC Conformity with EN50155 & EN50121-3-2	
Dimensions (WxDxH)	150 x 105 x 61 mm	192 x 140 x 58 mm		

### JCO NVIDIA® JETSON ORIN™ SERIES

### JCO-6000 SERIES ROBUST AI EDGE COMPUTER







IIVIDIA.			
Model	JCO-6000-ORN-A	JC0-6000-ORN-B	
	NVDIA® Jetson AGX Orin™ AI Computer with 8-core/12-core Arm® Cortex®-A78AE v8.2 64-bit CPU		
CPU Support	64G: 12-core Arm <sup>®</sup> Cortex <sup>®</sup> -A78AE v8.2 64-bit CPU (60W/275 TOPS) 32G: 8-core Arm <sup>®</sup> Cortex <sup>®</sup> -A78AE v8.2 64-bit CPU (40W/200 TOPS)		
System Memory	AGX Orin 32GB/64GB @ 3200 MHz on SOM 32GB LPDDR5 DRAM 64GB LPDDR5 DRAM		
Graphic Output	1x HDMI 2.0, 384	40 x 2160 @ 60Hz	
LAN	1 x GbE LAN, 1x 10 GbE LAN		
PoE	By Optional PoE Power Module, Support up to 3x 4-port LAN Module	By Optional PoE Power Module, Support up to 3x 4-port LAN Module	
	2x RS-232/422/485, 2x CAN	2x RS-232/422/485 (Optional, internal), 2x CAN (Optional, internal)	
I/O	1x USB 3.2 Gen 2, 1x USB 2.0 ( Flash) 1x USB 2.0, 1x USB Type C (Console) 8 in / 8 out (Isolated)		
GMSL Camera	GMSL 2 Camera Support by 2x Quad Port Mini Fa	akra, supporting 8x 1280x720 @ 30 FPS (Optional)	
Universal I/0 Bracket	2x Universal I/O Bracket	4x Universal I/O Bracket	
Storage	1x M.2 (M Key, 2242/2260/2280, PCIex 4, Support NVMe) 1x M.2 (B Key, 3042/3052,USB 3.2 Gen2, Support 4G/5G Module)		
Power	AT/ATX 9~48VDC, 3-pin Terminal Block		
Operating Temperature	-20°C to 60°C with passive cooling (at full CPU & GPU frequency with 0.6 m/s, non-throttling, 60W TDP mode)		
Certification	CE, FCC Class A, E-Mark, EMC Conformity with EN50155 & EN50121-3-2		
Dimensions (WxDxH)	270 x 190 x 95 mm		

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#### INDUSTRIAL-GRADE SUPERCAPACITOR FOR REDUNDANT POWER

### ECO-1000 EDGEBOOST ENERGYPACK More info



- 8x/16x Industrial 370 Farads Supercapacitors
- Up to 200W Max. Power Output
- 1x COM, 1x USB for GUI Remote Management and Monitoring
- 2 IN / 2 OUT DIO
- -25°C to 55°C Wide Operating Temperature
- EN50155: EN50121-3-2, CE, FCC Class A, UL Certification
- · 3x Smart Modes with Remote On/Off, Ignition Control, Delay Time
- 12V/24V Compatibility: Industrial PCs, Panel PCs, Displays







Model	ECO-1000	
Capacity	ECO-1000-8S: 8x 370 Farads Supercapacitors ECO-1000-16S: 16x 370 Farads Supercapacitors	
Input Voltage	12 ~ 35 VDC	
Input Connector	3-pin Terminal Block (V+, GND, IGN IN)	
Output Voltage	Charge mode: DC IN Voltage bypass (DC OUT = DC IN) Discharge mode: 12 or 24V	
Output Power	ECO-1000-8S: Max.100W output ECO-1000-16S: Max.200W output	
Output Connector	3-pin Terminal Block (V+, GND, IGN Out)	
1/0	1x RS-232, 1x USB Type A, 2x DI + 2x D0 with isolation	
Others	1x Remote Power On/Off 1x Smart Mode Switch, 1x Mode Reset Switch	
Power Ignition	Power Ignition Management	
Operating Temp	-25°C to 55°C	
CE, FCC Class A, UL 62368-1 Ed. 3 EMC Conformity with EN50155, EN50121-3-2		
Dimensions (WxDxH)	100 x 192 x 187.4 mm	
Weight	1.8 kg ~ 2.6 kg	
Mounting Options Wall Mounting, DIN Rail Mounting (Optional)		

### **Supercapacitor UPS System** Power Redundancy at the Rugged Edge

Power Backup | Safe Shutdown | Power Regulator



#### 8/16x

Up to 16x High-Density Industrial 370 Farads/SuperCAP

Regulate Voltage Fluctuation

12/24V

#### EN50155

ECO SERIES

Railway Certification for In-Vehicle Deployments

#### 10Y

10 years longevity 500K Lifcycle

#### 200W

Robust Max Power Output

#### **GUI**

GUI software for quick, easy setup

#### **3**x

Support 3 smart modes for various application deployments







### **C&T INDUSTRIAL DISPLAY SYSTEMS**

PRODUCT FAMILY



#### **PC/Monitor**

Module



Raptor Lake PS Alder Lake PS

PC100-EHL Ser Elkhart Lake

**PC400** S Kabylake-U

PC100 Bay Trail

MX200 Serie Monitor Module



### IP66/IP69K

Panel PC Stainless Steel

SIO-200 Bay Trail

SIO-300-N97

Alder Lake

WIO-W221C Kabylake-U



Panel PC

Alder Lake-N Thin Frame

AIO Series

HIO Series Alder Lake-N Open Frame

#### VIO-200/PC600-RPL

Raptor Lake PS Alder Lake PS

Kabylake-U Thin Frame

Elkhart Lake Bay Trail



VIO-200 S

Thin Frame

#### **Touch** Monitor

**Display**Module

VIO-200/MX200

Thin Frame

Thin Frame

#### VIO-200/PC400

### VIO-200/PC100-EHL VIO-200/PC100 Series

Thin Frame

VIO 4:3 SERIES More info



The Display Modules VIO-100 and VIO-200 series are compatible with PC modules PC600-RPL, PC400, PC100-EHL, PC100-J1900 and monitor modules MX200 series for different display sizes and touchscreens. These modules allow to be used for configuring, upgrading and maintaining your Panel PC or touch monitor

VIO-100 SERIES

VIO-200 SERIES

#### Standard Frame











Model	VIO-110	Model	VIO-212	VIO-215	VIO-217	VIO-219
LCD Size	10.4"	LCD Size	12.1"	15"	17"	19"
Max. Resolution	800 x 600 (SVGA)	Max. Resolution	1024 x 7	68 (XGA)	1280 x 10	24 (SXGA)
Brightness (cd/m2)	400	Brightness	600		350	
Contrast	700:1	(cd/m2)	(cd/m2) 1000 nits (Optional)		(Optional)	
Ratio	700:1	Contrast	100	00:1	800:1	1000:1
LCD Color	16.2M	Ratio	100		000.1	1000.1
Life Cyale		LCD Color	16.2M		16.7M	
Life Cycle Time	70K Hours	Life Cycle	50K Hours			
Viewing Angle	160 / 130	Time				
(H-V)	,	Viewing Angle (H-V)	178 / 178	170 / 160	178 / 178	170 / 160
Internal Speaker	AMP 5W + 5W	Internal				
	Resistive 5-wire	Speaker	AMP 5W + 5W		AMP 10W + 10W	
Touch Type	Touch / Projected Capacitive Touch	Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch		e Touch	
Operating Temperature	-10°C to 60°C	Operating Temperature		-10°C to 60°C		-10°C to 50°C

VIO 16:9 SERIES More info

### VIO-200 SERIES







Model	VIO-W215	VIO-W215 VIO-W221	
LCD Size	15.6"	21.5"	23.8"
Max. Resolution	1920 x 1080 (Full HD)		
Brightness	50	00	450
(cd/m2)	1000 nits	(Optional)	
Contrast Ratio	1000:1		
LCD Color	16.7M		
Life Cycle Time	50K Hours 30K Hours		
Viewing Angle (H-V)	178 / 178		
Internal Speaker	AMP 10W + 10W		
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch		
Operating Temperature	-10°C to 60°C -10°C to 50°C		



### VIO-200-PC600-RPL SERIES

### VIO-200/PC400 SERIES Moreinfo





INDUSTRIAL PANEL PC







NEW
Die Europe

Model	VIO-200-PC600-RPL	VIO-200-PC600-RPL-1E	
	Thin Frame Industrial Panel PC based on Intel <sup>®</sup> 12 <sup>th</sup> & 13 <sup>th</sup> Processor	Thin Frame Industrial Panel PC based on Intel® 12 <sup>th</sup> & 13 <sup>th</sup> Processor 1x PCIe x4 Gen3	
CPU Onboard	Intel® 12 <sup>th</sup> /13 <sup>th</sup> Gen. (ADL-PS /RPL-PS) Processor Core™		
Memory	1x DDR5 4800 MT/s SO	-DIMM Max up to 16GB	
Graphic Output	1x DisplayPort, 1x HDMI , 1	x Dual Channel 24 bit LVDS	
LAN	2x 2.5GbE i226 RJ45 (Suppo	ort Wake-on-LAN and PXE)	
USB, Serial, & Digital I/O	3x USB 3.2 Gen 2 (10 Gbps),1x USB C 3.2 Gen 2, Up to 4x RS-232/422/485, 16x isolated digital I/O		
Storage	1x 2.5" SATA HDD Bay with RAID 0, 1 support, 1x M.2 M-key / NVMe PCIe x4 / 2242, 2260, 2280 2x M.2 B-key /PCIe x2 /USB / 2242, 3042, 3052		
Internal Expansion Slot	1x M.2 E-Key / PCle x1 / USB 2.0 / 2230		
PCIe	1x PCle x4 Gen3		
Power	9-48 VDC, AT/ATX Select, 3-pin Terminal Block		
Audio	Line-out / Mic-in Phone Jack		
Operating Temperature	-10 °C to 60 °C -10 °C to 50 °C (19"/21.5"/23.8" Panel PC only)		
LCD Size	4:3 12.1" / 15" / 17" / 19" 16:9 15.6" / 21.5" / 23.8"		
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch		
Universal Expansion Slot	0 2		

ntel	
ahvlake-II	





Model	VIO-200/PC400	VIO-200/PC410	
	Thin Frame Industrial Panel PC based on Intel® Kabylake-U processors	Thin Frame Industrial Panel PC based on Intel® Kabylake-U processors with 2x universal I/O bracket	
CPU Onboard	Intel® 7 <sup>th</sup> Gen. (Kabylake-U) Processor Core™ i5-7300U, Core™ i3-7100U		
Memory	1x 260-Pin DDR4 1866/2133M	Hz SO-DIMM. Max. up to 16GB	
Graphic Output	1x VGA, 1x DisplayPort, 1x	Dual Channel 24 bit LVDS	
LAN	2x GbE RJ45 (Support V	Wake-on-LAN and PXE)	
USB, Serial, & Digital I/O	4x USB 3.2 Gen1 (5 Gbps), up to 6x RS-232/422/485, 16x isolated digital I/O		
Storage	1x 2.5" SATA HDD Bay with RAID 0, 1 support, 1x mSATA (shared by 1x Mini PCle, 1x CFast (shared by 1x mSATA)		
Internal Expansion Slot	2x Full-size Mini PCIe		
Power	9-50 VDC, AT/ATX Select, 3-pin Terminal Block		
Audio	Line-out / Mic-in Phone Jack		
Operating Temperature	-10 °C to 60 °C -10 °C to 50 °C (19"/21.5"/23.8" Panel PC only)		
LCD Size	<b>4:3</b> 12.1" / 15" / 17" / 19" <b>16:9</b> 15.6" / 21.5" / 23.8"		
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch		
Universal Expansion Slot	0	2	



VIO-200/PC100-EHL SERIES More info

Model	VIO-200/PC100-EHL	VIO-200/PC100-EHL-1E	
	Thin Frame Industrial Panel PC based on Intel® Celeron® processors		
CPU Support	Intel <sup>®</sup> Celeron <sup>®</sup> J6413 Processor Qua	d core (1.5M Cache,1.8GHz up to 3.00 GHz)	
Memory	1x 260-Pin DDR4 2400/2667/32	200MT/s SODIMM. Max. up to 32 GB	
Graphic Output	1x DisplayPort 1.2,	1x HDMI 2.0b (Optional)	
LAN	2x RJ45	[1 & 2.5 GbE]	
1/0	2x USB 3.2 Gen 2, 2x USB 2.0, 6x RS-232/422/485 (2x internal), 16x isolated digital I/O, 1x Mic-in, 1x Line-out		
Storage	1x Removable 2.5" SATA HDD Bay, 1x mSATA		
M.2	1x M.2 (E Key, PCIe x1, USB 2.0, 2230) 1x M.2 (B Key, PCIex 2 + USB 3.2 Gen1, 2242/3042/3052)		
Internal Expansion Slot	1x Full-size Mini	PCIe (USB 2.0, SATA)	
PCIe	1x PCIe x4 (1-lanes)		
Power	9-36 VDC, AT/ATX Se	lect, 3-pin Terminal Block	
Operating Temperature	-10 °C to 60 °C, -10 °C to 50 °C (19"/21.5"/23.8" Panel PC only)		
LCD Size	4:3 12.1" / 15" / 17" / 19"	<b>16:9</b> 15.6" / 21.5" / 23.8"	
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch		
Universal Expansion Slot	0 1x Universal I/O Bracket (By mini PCIe interface)		

### VIO-200/PC100 SERIES More info

intel<sub>®</sub>





W 1.1	VII.O. 000/D0400	VII.0 000/D0110		
Model	VIO-200/PC100	VIO-200/PC110		
	Thin Frame Industrial Panel PC based on Intel® Bay Trail processors			
CPU Onboard	Intel® Celeron® J1900			
Memory	1x 204-pin DDR3L-1066/1333 SO-DIMM, up to 8GB			
Graphic Output	1x VGA, 1x DisplayPort			
LAN	2x GbE RJ45 (Support Wake-on-LAN and PXE)			
1/0	1x USB 3.2 Gen1 (5 Gbps), 3x USB 2.0, 6x RS-232/422/485 (w/ 2x internal), 16x isolated digital I/O, Line-out / Mic-in Phone Jack			
Storage	1x 2.5" SATA HDD Bay, 1x mSATA (shared by 1x Mini PCle), 1x CFast (shared by 1x mSATA & 1x Mini PCle)			
Internal Expansion Slot	1x Full-size Mini PCIe Socket with USIM Socket (PCIe + USB + SATA) 1x Full-size Mini PCIe Socket with USIM Socket (PCIe + USB)			
Power	9-50 VDC, AT/ATX Select, 3-pin Terminal Block			
Operating Temperature	-10 °C to 60 °C, -10 °C to 50 °C (19"/21.5"/23.8" Panel PC only)			
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch			
Universal Expansion Slot	0	2		

### VIO-200/MX200 SERIES More info

- 12.1"  $\sim$  23.8" Thin Frame Full Range Touch Monitors
- Projected Capacitive and 5-wire Resistive Touchscreen Available
- 9 to 48 VDC Wide Range Power Input
- Aluminum Die-casting Front Frame

INDUSTRIAL TOUCH MONITOR

• Front Panel IP65 Rating



Model	VIO-200/MX200
	Thin Frame Industrial Touch Monitor
Touch Type	Resistive / Capacitive Touch
VGA	1x VGA Input
HDMI	1x HDMI Input
DisplayPort	1x DisplayPort Input
USB	1x USB 2.0 Input
COM Port	1x COM Port Input / Resistive
Audio	1x Audio Input
Power	9-48 VDC, AT/ATX Select, 3-pin Terminal Block
Operating Temperature	-10 °C to 60 °C -10 °C to 50 °C (19"/21.5"/23.8" Panel PC only)
LCD Size	<b>4:3</b> 12.1" / 15" / 17" / 19" <b>16:9</b> 15.6" / 21.5" / 23.8"



SIO-200 SERIES More info













Model	SIO-215-J1900	SIO-W215-J1900	SIO-W221-8365UE	SIO-W224-8365UE
	Resistive / Capacitive Touch Stainless Steel Panel PC, Pressure Valve SUS316 VENT			
CPU Support	Intel <sup>®</sup> Celeron <sup>®</sup> Processor J1900, Quad Core, 2MB Cache, 2.0 GHz		Intel <sup>®</sup> Core™ i5-8365UE Processor 6M Cache, up to 4.10 GHz	
Memory	1x 204-pin DDR3L SO-DIMM, Max 8GB (Default 8 GB)		1x 260-Pin DDR4 2400MHz SO-DIMM slot, Max 32GB (Default 8 GB)	
LAN		2x LAN by M1	2 X-Code 8-pin	
1/0	4x USB 2	.0 by M12 A-code 8-pin, 2x F	RS-232/422/485 by M12 A-C	ode 8-pin
Storage	1x mSATA (Default 128 GB)			
Internal Expansion Slot	1x Full-size Mini PCIe			
Power	AC IN 110V~240V, M12 S-code 4-pin			
Operating Temperature	-20 °C to 55 °C		-20 °C to 50 °C	
LCD Size	15" (4:3) TFT XGA	15.6" (16:9) Full HD	21.5" (16:9) Full HD	23.8" (16:9) Full HD
Brightness (cd/m2)	300	450	350	450
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch			
IP Level	Full System IP66/IP69K			
Dimensions (WxHxD)	385 x 310 x 49.5 mm	425 x 276 x 49.5 mm	588.5 x 380 x 52.8 mm	623 x 417 x 54 mm
Weights	5.96 kg	7.39 kg	8.6 kg	11.7 kg
Mounting Options	, and the second		VESA Mounting Hol 200 x 100mm, Optional Y	les 100 x 100mm or Yoke Mount, Panel Mount

### SIO-300-ADLN SERIES

### intel. Alder Lake













Model	SIO-315-N97	SIO-W315-N97	SIO-W321-N97	SIO-W324-N97
		oacitive Touch Stainless Ste	el Panel PC, Pressure Valve	SUS316 VENT
CPU Support	Intel® Processor N97 61	M Cache, up to 3.60 GHz	Intel® Processor Intel® Core™ i3-N305	
Memory	DDR5 4800MT/s SO-DIMM, Max 16GB (Default 8 GB)			
LAN	2x LAN by M12 X-Code 8-pin			
1/0	2x USB 2.0 by M12 A-code 8-pin, 2x RS-232/422/485 by M12 A-Code 8-pin			
Storage	M.2 B Key NVMe SSD (Default 128 GB)			
Power	AC IN 110V~240V, M12 S-code 4-pin			
Operating Temperature	-20 °C to 50 °C			
LCD Size	15" (4:3) TFT XGA	15.6" (16:9) Full HD	21.5" (16:9) Full HD	23.8" (16:9) Full HD
Brightness (cd/m2)	300	450	350	450
Touch Type		Resistive 5-wire Touch / P	Projected Capacitive Touch	
IP Level	Full System IP66/IP69K			



• 21.5" TFT FHD 16:9 LCD with Projected Capacitive Touch

IP66 WATERPROOF TOUCHSCREEN COMPUTER

- Support  $7^{th}$  Gen. Intel $^{\otimes}$  Core<sup>TM</sup> i5 / i3 Processor
- 1x 260-pin DDR3L SO-DIMM. Max up to 8GB
- 1x mSATA (shared by 1x Mini PCIe), 2x internal SIM socket
- Single display supported by 1x VGA (waterproof connector)
- 2x LAN by M12 X-Code 8-pin
- 1x RS-232/422/485 by M12 D-Code 8-pin

- 2x USB 3.2 Gen1 (5 Gbps, waterproof connector)
- 9 to 50 VDC wide range power input
- -10°C to 60°C extended operating temperature
- Full system IP66 compliant
- Two 10W internal speakers built-in
- Multi-language OSD built-in





Model	WIO-W221C
	21.5" 16:9 Full HD Capacitive Touch All-In-One IP66 Panel PC
CPU Onboard	Intel® 7 <sup>th</sup> Gen. (Kaby Lake-U) Processor Core™ i5-7300U, Core™ i3-7100U
Memory	8GB DDR4 SO-DIMM
Graphic Output	1x Waterproof VGA
LAN	2x LAN by M12 X-Code 8-pin
USB & Serial	2x USB 3.2 Gen1 (5 Gbps, Waterproof connector), 1x RS-232/422/485 by M12 D-Code 8-pin
Storage	1x 128GB mSATA SSD
Internal Expansion Slot	1x Full-size Mini PCIe
Power	9-50 VDC, M12 A-code 4-pin
Operating Temperature	-10 °C to 60 °C
LCD Size	21.5" (16:9) Full HD
Brightness (cd/m2)	300
Drighthess (cu/mz)	1000 nits (Optional)
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch / 7H Surface Hardness

#### ALL IN ONE TOUCH PANEL PC

### **AIO** SERIES

- 10.1" ~ 21.5" All IN One Touch Panel PC
- World Class Certifications for Safety and Reliability: CE/FCC/CB/UL/UKCA/IC
- Front IP65 Rating for protection against water and dust
- Scratch Resistant 7H Glass Hardness
- Versatile Display Outputs; HDMI and DP
- 9 to 36 VDC Wide Range Power Input
- Front Panel IP65 Rating

### intel

AIO SERIES







Model	AIO-W210-N97	AIO-W215-N97	AIO-W221-N97
	Capacitive Open Frame Touch Panel PC with Intel®Alder lake N97 Processor		
CPU Onboard	Intel® Alder lake N97 6M Cache, up to 3.60 GHz		
Memory	Default 8GB DDR5 4800MT/s S0DIMM (up to 16GB)		
Graphic Output	HDMI / DP / LVDS /eDP		
LAN		2x 2.5GbE I225 LAN	
1/0	6x USB 2.0 by internal cable, 4x USB 3.2 Gen 2 2x RS-232/422/485 by internal cable 1x Audio out		
Storage	128G M.2 B Key NVMe SSD		
Expansion	M.2 E Key Support WiFi 6e (Optional)		
Power	9-36V DC, DC Jack 5.5mm/2.5mm, 60W (12V 5A, Default)		
Operating Temperature	-10°C to 50°C		
Certification	CE, FCC, CB, UL, UKCA, IC		
LCD Size	10.1" (16:10) WXGA	15.6" (16:9) FHD	21.5" (16:9) FHD
Brightness (cd/m2)	400 nits 500 nits		
Projected Capacitive		7H / IK07	
Dimensions (W) x (H) x (D)	256 x 170 x 50 mm 400 x 249 x 50 mm		538 x 329 x 62 mm

#### CAPACITIVE OPEN FRAME TOUCH PANEL PC

### HIO SERIES

- 10.1" ~ 21.5" Open Frame Touch Panel PC
- World Class Certifications for Safety and Reliability: CE/FCC
- Front IP65 Rating for protection against water and dust
- Scratch Resistant 7H Glass Hardness
- Versatile Display Outputs; HDMI and DP
- 9 to 36 VDC Wide Range Power Input
- Front Panel IP65 Rating







### intel.

Model	HIO-W210-N97	HIO-W215-N97	HIO-W221-N97
	Capacitive Open Frame Touch Panel PC with Intel®Alder lake N97 Processor		
CPU Onboard	Intel <sup>®</sup> Alder lake N97 6M Cache, up to 3.60 GHz		
Memory	Default 8GB DDR5 4800MT/s SODIMM (up to 16GB)		
Graphic Output	HDMI / DP / LVDS /eDP		
LAN	2x 2.5GbE 1225 LAN		
1/0	6x USB 2.0 by internal cable, 4x USB 3.2 Gen 2 2x RS-232/422/485 by internal cable 1x Audio out		
Storage	128G M.2 B Key SSD (Default)		
Expansion	M.2 E Key Support WiFi 6e (Optional)		
Power	9-36V DC, DC Jack 5.5mm/2.5mm, 60W(12V 5A) Adapter (Optional)		
Operating Temperature	-10°C to 50°C		
Certification	CE, FCC Class A		
LCD Size	10.1" (16:10) WXGA 15.6" (16:9) FHD		21.5" (16:9) FHD
Brightness (cd/m2)	400 nits 500 nits		
Projected Capacitive	7H / IK07		
Dimensions (W) x (H) x (D)	252 x 166 x 39 mm	533 x 325 x 46 mm	

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# INDUSTRIAL BOARD SOLUTIONS

C&T's line of industrial motherboards and single board computers represent the standard of embedded computing as well as the future of data processing and I/O connectivity. From OEM /ODM enterprise computing designs to embedded single board computer applications, C&T provides reliability and longevity with standard off-the-shelf industrial grade motherboards for the most challenging embedded deployments.

We also provide end-to-end engineering services to ensure your configuration requirements and solve your mechanical design challenges. From a full custom solution to a small change in the I/O, we can adapt each motherboard to comply with your specifications without compromising performance.



Industrial-Grade Materials



Tested and Validated



Long Product Lifecycle



Fast Delivery Time

## INDUSTRIAL MOTHERBOARDS & SINGLE BOARD COMPUTERS

## intel

3.5" ADL-N

Coming soon

SBC with Intel® Alder Lake N Series



3.5" Meteor Lake-N

SBC with Intel® Alder Lake N Series

2.5" ADL-N



SBC with Intel® Alder Lake N Series

#### Mini-ITX Meteor Lake PS



Industrial Motherboard with Intel® Meteor Lake PS

### BOARDS SERIES More info



C&T offers industrial-grade scalability with standard motherboards and OEM system design. Standard form factors include: Single board computers (1.8" Femto-ITX, 2.5" PICO-ITX, and 3.5" SBCs); Mini-ITX; and Micro-ATX.

### 1.8" FEMTO ITX SERIES







Model	CT-NR101
	AMD Ryzen™ Embedded R1606G with Radeon™ Vega 3 Graphics - Highest 2C Performance
Memory	DDR4-2400 signal channel Memory down, up to 8GB Default 4GB
BIOS	AMI SPI 64Mbit
TPM	TPM 2.0
Display Interface	2x Micro HDMI
Rear I/O	1x RJ45, 2x Micro HDMI, 1x Type C USB 3.1 Gen 2
Internal I/O	1x Front Panel, 1x 8-bit GPIO (4-in/4-out)
Power	2-pin Terminal Block
Operating Temperature	0°C to 60°C
Dimension	84 x 55 mm

Model	CT-PBT01
	Intel® Celeron® Processor J1900 (2.0GHz/4C/10W)
Memory	1x 204-Pin DDR3L 1066/1333MHz SO-DIMM
BIOS	AMI 64Mbit SPI BIOS
Watchdog	Software Programmable Supports 1–255 sec. System Reset
Display Interface	1x HDMI, 1x LVDS
Rear IO	1x LVDS & 1x LVDS backlight, 1x RS-232/422/485, 1x RS-232, 2x USB 2.0
Internal I/O	1x LVDS, 1x LVDS backlight, 1x RS-232/422/485, 1x RS-232, 2x USB 2.0, 1x SATA 3.0Gb/s, 1x Front panel audio, 1x 8-bit GPIO (4-in/4-out), 1x Front panel, 1x SMBus
Power	12V DC Input, 1x 2-pin power connector
Operating Temperature	-10°C to 70°C
Dimension	100 x 72 mm

### BOARDS SERIES More info

### 3.5" SBC SERIES









Model	CT-DWL01	CT-DR101	CT-DR101
	Support 8 <sup>th</sup> Gen. Intel® WL-UE Processor (15 TDP) Int el® Core™ i7-8665UE, i5-8365UE, i3-8145UE or Intel® Celeron® Processor 4305UE	AMD Ryzen™ Embedded R1000/V1000 Series Processor	Intel <sup>®</sup> 12 <sup>th</sup> Gen Alder Lake-N N97/i3-N305 Processors
Memory	1x 260-Pin DDR4 2400MHz SO-DIMM slot. Max. up to 32GB	DDR4-2400 SO-DIMM slot up to 32GB, supports ECC	1x 262-Pin DDR5 4800MHz SO- DIMM slot (262-pin), Max 16GB
BIOS	AMI uEFI 256MB SPI flash	AMI uEFI 256Mbit SPI flash	AMI uEFI 256MB SPI flash
Watchdog	Software Programmable Supports 1~255 sec. System Reset	Software Programmable Supports 1~255 sec. System Reset	Software Programmable Supports 1~256 sec. System Reset
TPM	TPM 2.0 Through Infineon® SLB9665TT2.0 or Equivalent	TPM 2.0	
Display Interface	1x DisplayPort, 1x LVDS, 1x HDMI, 1x EDP internal connector (optional)	1x DisplayPort, 1x LVDS, 1x HDMI	
Rear IO	4x USB 3.2 Gen 2, 2x RJ45 GbE LAN, 1x DisplayPort, 1x HDMI	2x RJ45, 2x USB 3.2 Gen2 (10Gbps), 2x DisplayPort, 1x HDMI	3x RJ45 2x USB 3.2 Gen2 (10Gbps), 2x USB 3.2 Gen 1 (5Gbps) 1x DisplayPort, 1x HDMI
Internal I/O	1x LVDS, 1x eDP1.4 (Optional), 4x RS-232/422/485, 2x USB 2.0, 2x SATA Gen3, 1x Front panel audio, 2x 4-bit DIO	1x 24-bit dual channel LVDS, 2x RS232/422/485, 1x SATA, 2x 6pin Audio Header, 2x 4-bit DIO, 1x 50-pin PCIe 3.0 (4-Lane) Connector for Custom I/Os	1x GPIO header, 2x RS-232-/422/485 Internal 2.0PH headers, 1x SATA, 1x Audio front panel header, 1x LVDS connector, 1x eDP connector, 6x USB 2.0 Internal 2.0 Headers
Power	AT/ ATX 12V DC Input, 4-pin CPU P4 connector	AT/ ATX 12V DC Input, 4-pin CPU P4 connector	9~36V DC Input
Operating Temperature	-40°C to 70°C	-40°C to 75°C	-10°C to 60°C
Dimension		146 x 102 mm	

### BOARDS SERIES More info





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### MINI ITX SERIES





Model	CT-XCL01		
	LGA 1151 Socket Support 9 <sup>th</sup> Gen. Intel <sup>®</sup> Core™ Desktop Processor, Q370 Chipset		
Memory	2x SO-DIMM, DDR4, 2133/2400/2666 (depend on CPU) MT/s, Max 32 GB		
BIOS	AMI <sup>®</sup> UEFI BIOS 256Mb Flash		
Watchdog	Software Programmable Supports 1~255 sec. System Reset		
TPM	TPM 2.0 Through Infineon® SLB9665TT2.0 or Equivalent (Optional)		
Display Interface	1x DVI-D, 1x LVDS, 1x HDMI 1.4, 1x DisplayPort 1.2		
Rear IO	1x RS-232, 2x RJ45, 4x USB 3.1 Gen 2, 1x USB-C (optional), 1x Line-in , Line-out, Mic-in		
Internal I/O	4x RS-232 Headers, 1x 8-bit PIO, 1x USB 3.0 Headers (2 Ports), 1x USB 2.0 Headers (2 Ports), 1x Backlight Locking Type Header, 2x 4-pin PWM Smart Fan, 1x LPC Header, 1x SPI Header, 1x Cable Stype CMOS Battery		
Power	ATX 12V, 24 Pin ATX Power Connector		
Operating Temperature	0°C to 60°C		
Dimension	170 x 170 mm		

Model	CT-XSL01		
	LGA 1151 socket supporting 6 <sup>th</sup> Gen Intel <sup>®</sup> Core™ i3/i5/i7 Desktop Processor, Intel <sup>®</sup> Core™ i7-6700TE / i5-6500TE / i3-6100TE		
Memory	2x 260-Pin DDR4 1866/2133MHz SO-DIMM		
BIOS	AMI uEFI 128MB SPI flash		
Watchdog	Software Programmable Supports 1~255 sec. System Reset		
TPM	TPM 2.0 supported (optional)		
Display Interface	1x DVI-D, 1x 2-ch 24-bit LVDS, 1x DisplayPort		
Rear IO	1x DVI-I, 1x DP, 1x HDMI, 1x RS-232/422/485, 4x USB 3.2 Gen1 (5 Gbps), 2x USB 2.0, 2x RJ45, 1x Line-out, 1x Mic-in, 1xPS/2 KB/MS		
Internal I/O	1x 2-ch 24-bit LVDS, 4x RS-232, 2x USB 3.2 Gen1 (5 Gbps), 2x USB 2.0, 4 x SATA 6.0Gb/s, 1x Front panel audio, 1x 8-bit GPIO (4-in/4-out), 1x LPC, 1x Front panel, 1x CPU fan, 1x System fan		
Power	ATX power, 2x12-pin and 2x2-pin power connector		
Operating Temperature	0°C to 60°C		
Dimension	170 x 170 mm		

### BOARDS SERIES More info



### MICRO ATX SERIES







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Model	CT-MSL01	CT-MCL01	CT-MRL01	
	LGA 1151 socket supporting 6 <sup>th</sup> Gen Intel® Core™ i3/i5/i7 Desktop Processor, Intel® Core™ i7-6700TE/ i5-6500TE / i3-6100TE	Support 8 <sup>th</sup> /9 <sup>th</sup> Gen Intel® CFL-R S Processor (LGA 1151, 95W/65W/35W TDP), Intel® Core™ i7-9700E / i5-9500E / i3-9100E or Intel® Pentium® G5400T, G5400	Support 12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Intel <sup>®</sup> Core™ i9/i7/i5/i3 Alder lake-S, Raptor Lake-S Processor	
Memory	4x 288-Pin DDR4 1866/2133MHz DIMM	4x 288-Pin DDR4 2133/2400/2666MHz DIMM	4x DDR4 2133/2400/2666MHz DIMM. 128 GB Max	
BIOS	AMI uEFI 128MB SPI flash	AMI uEFI 128MB SPI flash AMI uEFI 256MB SPI flash		
TPM	TPM 2.0 supported (optional)		TPM 2.0	
Display Interface	1x VGA, 1x DVI-D, 1x DisplayPort	1x VGA, 1x DVI-D, 2x DisplayPort (DP 1.2)	Quad 4K Displays through 4x DP++	
Rear IO	1x VGA, 1x DVI-D, 1x DP, 1x HDMI, 2x RS-232/422/485, 4x USB 3.2 Gen1 (5 Gbps), 2x RJ45 GbE LAN, 1x Line-in, 1x Line-out, 1x Mic-in	1x VGA, 1x DVI-D, 2x DP, 2x RS-232/422/485, 4x USB 3.2 Gen 2, 2x RJ45, 1x Line-in, 1x Line-out, 1x Mic-in	4x DP++, 6x USB 3.1 Gen 2, 2x RJ45, 1x Line-in, 1x Line-out, 1x Mic-in, 1x USB 3.2 Gen 2x2 Type C	
Internal I/O	4x RS-232, 2x USB 3.2 Gen1 (5 Gbps), 6x USB 2.0, 4 x SATA 6.0Gb/s, 1x Front panel audio, 1x 8-bit GPIO (4-in/4-out), 1x PS/2 KB/MS, 1x LPC, 1x Front panel, 1x CPU fan, 2x System fan	4x RS-232, 1x USB 3.2 Gen 1, 7x USB 2.0, 6 x SATA 6.0Gb/s, 1x Front panel audio, 1x 8-bit DIO (4-in/4-out), 1x SPI header, 1x LPC, 1x Front panel, 1x CPU fan, 2x System fan	6x RS-232, 2x USB 3.0 Gen 1, 4x USB 2.0, 4 x SATA Gen 3, 1x Front panel audio, 1x 8-bit DIO (4-in/4-out), 1x SPI header, 1x Front panel, 1x CPU fan, 2x System fan	
Power	ATX power, 2x12-pin and 2x2-pin power connector		ATX Power, 2x12-pin and 2x2-pin power connector	
Operating Temperature	0°C to 60°C			
Dimension	244 x 244 mm			



